



**UNIVERSITY WITH POTENTIAL FOR EXCELLENCE
IN
BIOMEDICAL ENGINEERING AND
INSTRUMENTATION**



Funded by
UGC
Electronic System Design

PCB Fabrication And Testing Facility

- Name of the Equipment : **Reflow Oven**
- Description : 1. A Reflow oven is a machine used primarily for reflow soldering of surface mount Electronic components to printed circuit board.
2. It contains Conveyor, Foam fluxer with integral air compressor, Preheaters, Stainless Steel solder pot with drain valve.
- Stock Entry : Non Consumable Stock Register UPE-ESD Volume I Page. No – 18
- Utilization : Research and Product developers from among Indian Universities, National Institutions, National R&D labs and Industries.